



核数据重点实验室

# The Progress of GEM foil at CIAE

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# Outline

- **The progress of GEM foil at CIAE**
- **Other developments**



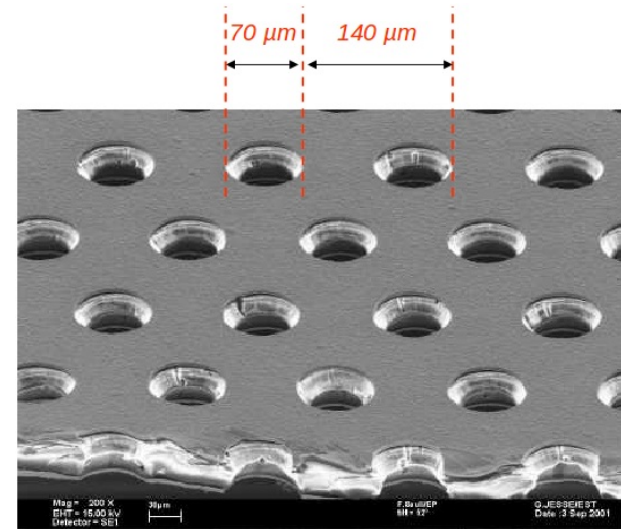
# The Progress of GEM Foil at CIAE



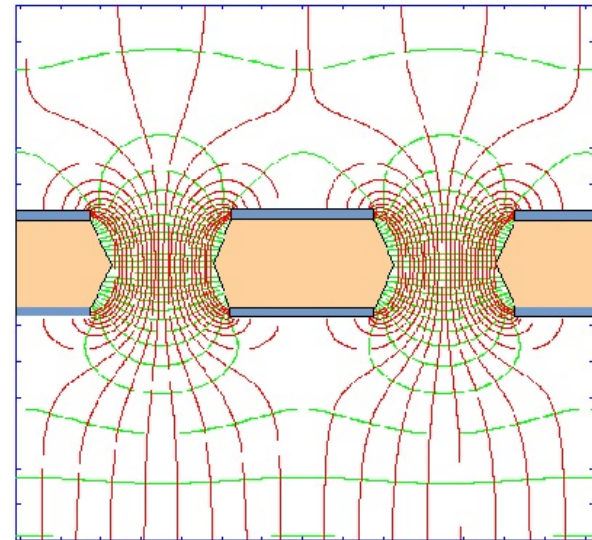


# GEM Foil Structure

1. Typical GEM Foil has 3 layers, two  $5\mu\text{m}$  thick copper foils and one  $50\mu\text{m}$  thick kapton foil in the middle.
2. Diameter of the hole is  $70\mu\text{m}$ , and the distance between them is  $140\mu\text{m}$ .
3. Apply electric voltages on the two copper layers.
4. Electric Field is very strong in the hole area, and weak outside the hole area.



GEM Foil



GEM Field

# Clean Room



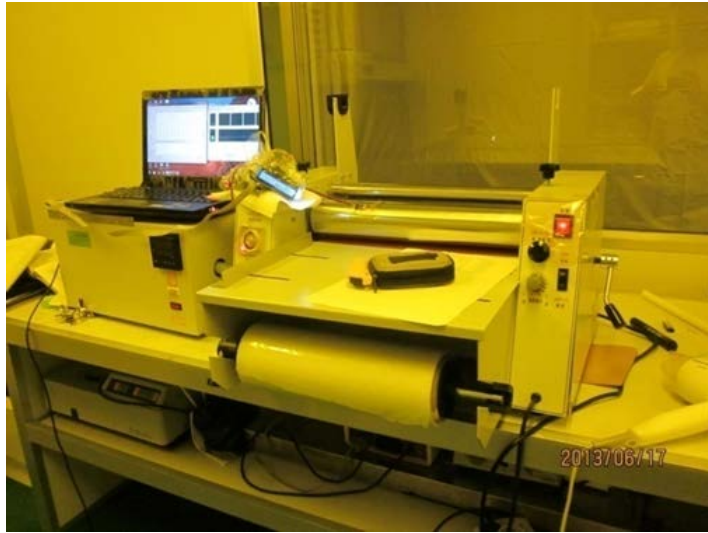
**The cleanrooms at China Institute of Atomic Energy are ISO Class 6.**

# Photolithography Lab Construction At CIAE



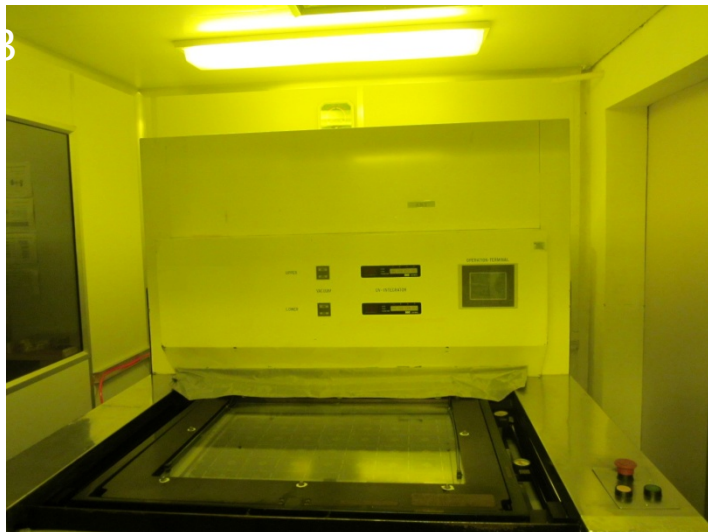


# The Equipments for Lamination and Exposure of Dry Film Photoresist



Lamination and exposure of dry film photoresist are the most important and difficult steps for GEM foil production.

We have established a yellow light zone, and have introduced Hot Roll Lamination (HRL) machine and Exposure system.



We invited the Senior engineer from a famous electronic factory to CIAE and teach the PCB technology.

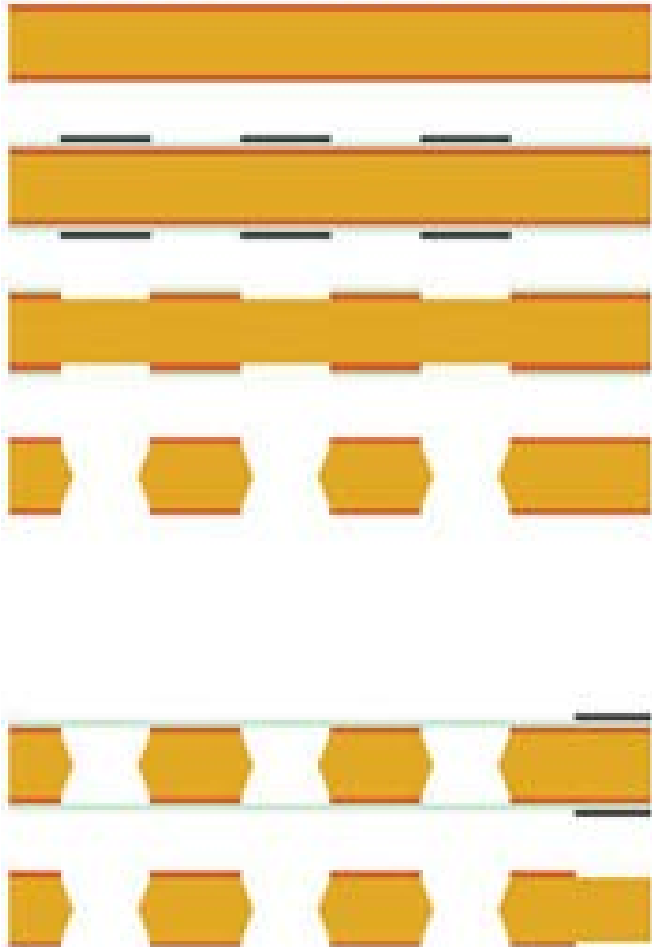
# Etching Room Construction





# The Procedure of GEM Foil

## Double mask photolithography



50  $\mu\text{m}$  kapton foil 5  $\mu\text{m}$   
copper clad on both sides

Photoresist coating,  
masking, exposure

Photoresist development,  
copper etching

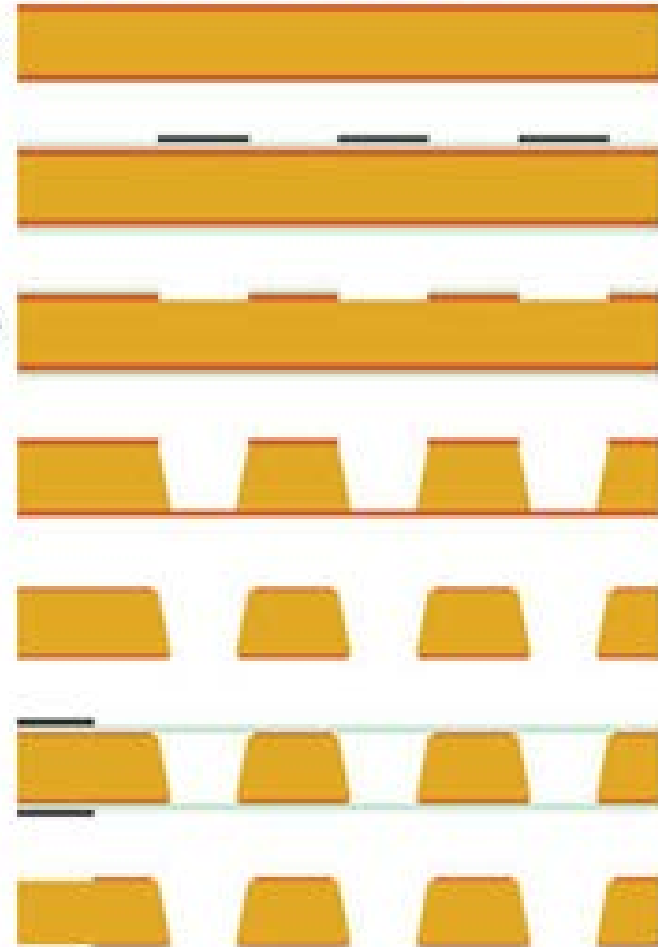
Kapton etching

Metal etching

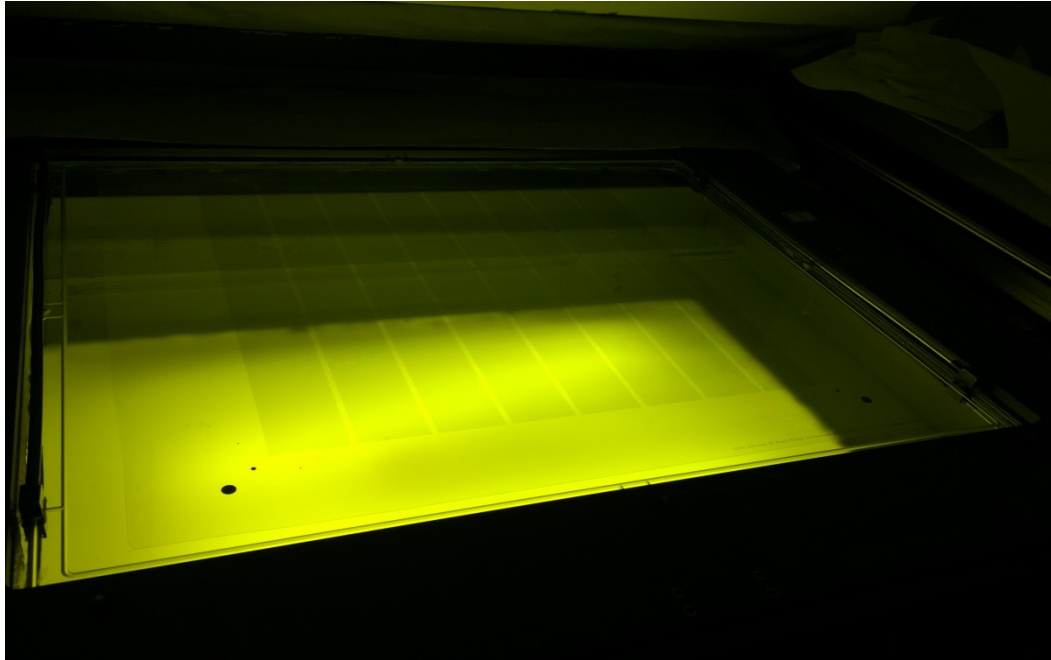
Second masking,  
exposure

Development, etching,  
final cleaning

## Single mask photolithography

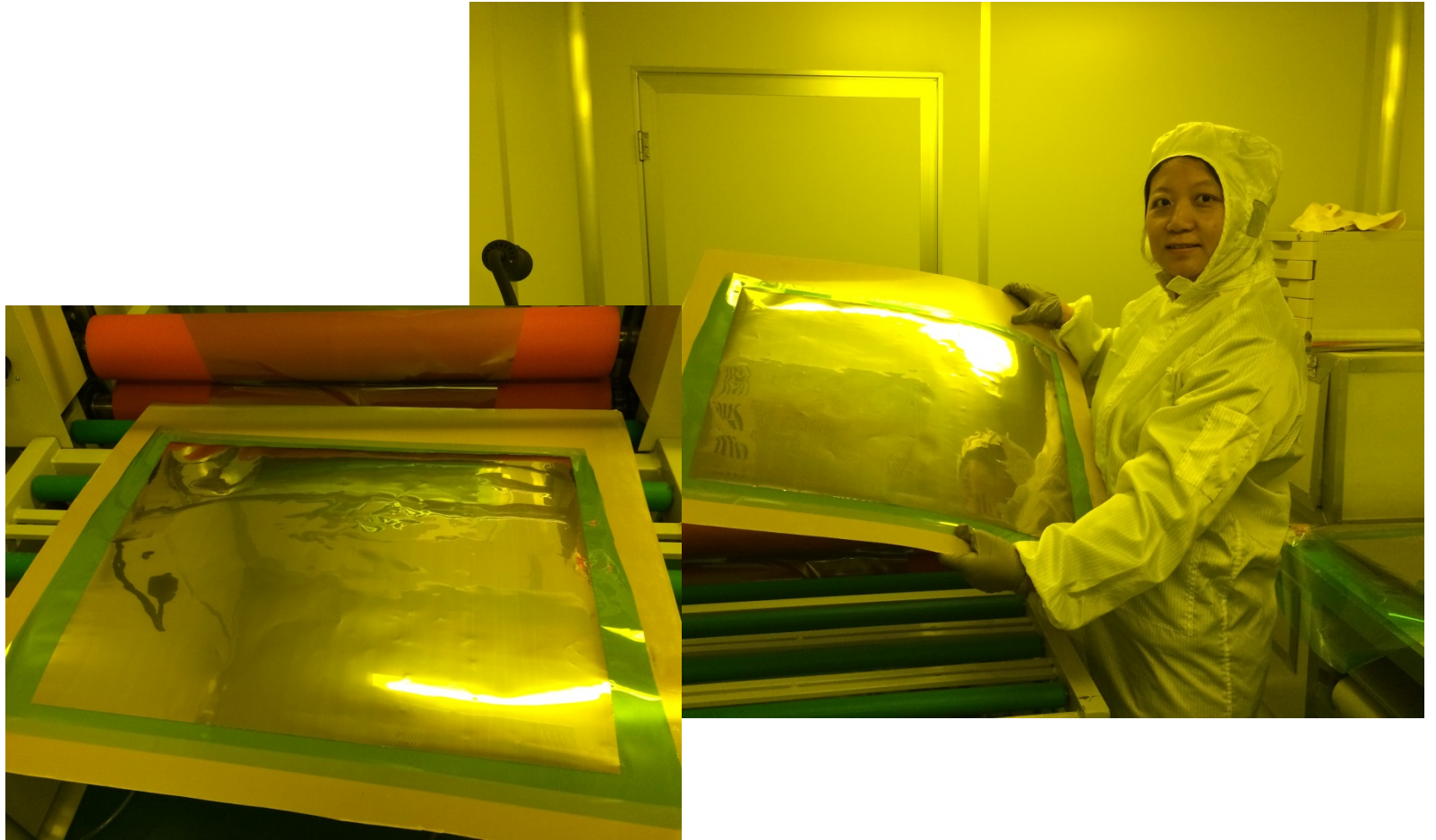


# GEM Photo Mask Plate



The copies of the photo-mask are done by photolithographic techniques.  
40cm\*40cm photo mask is produced.

# Lamination of Dry Film Photoresist

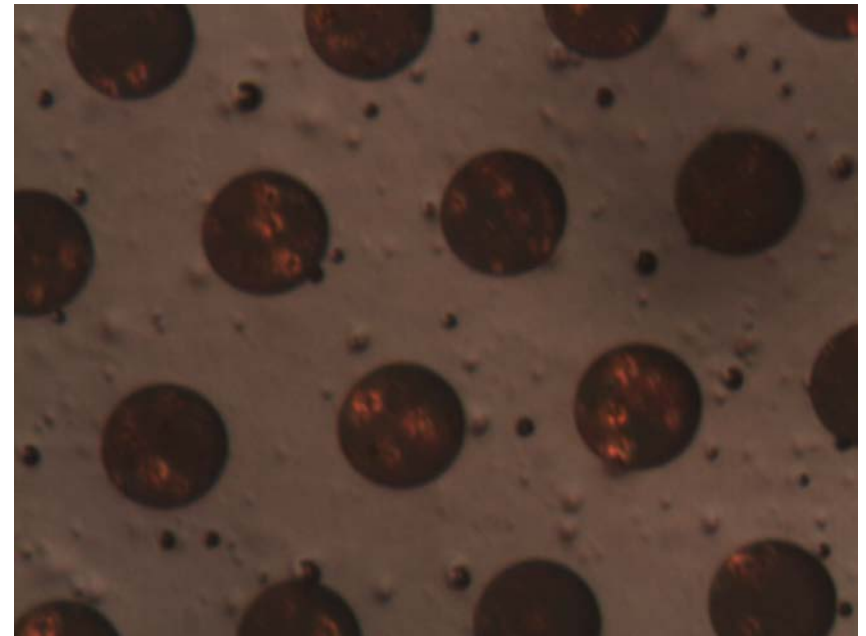
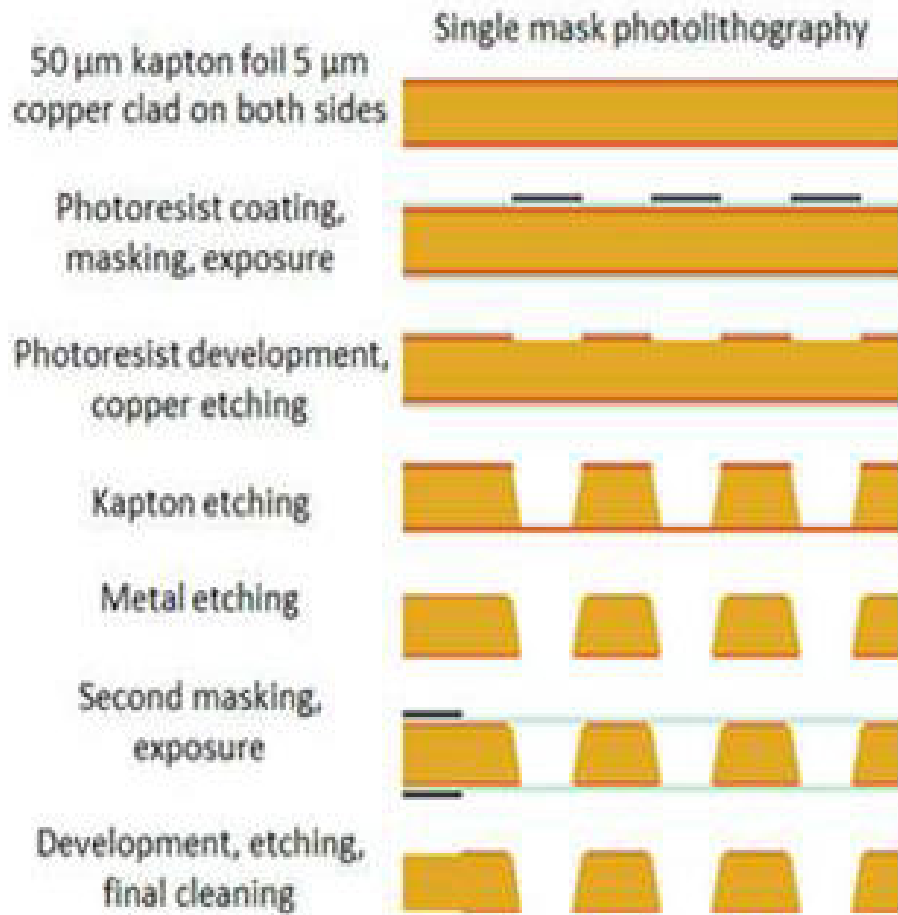




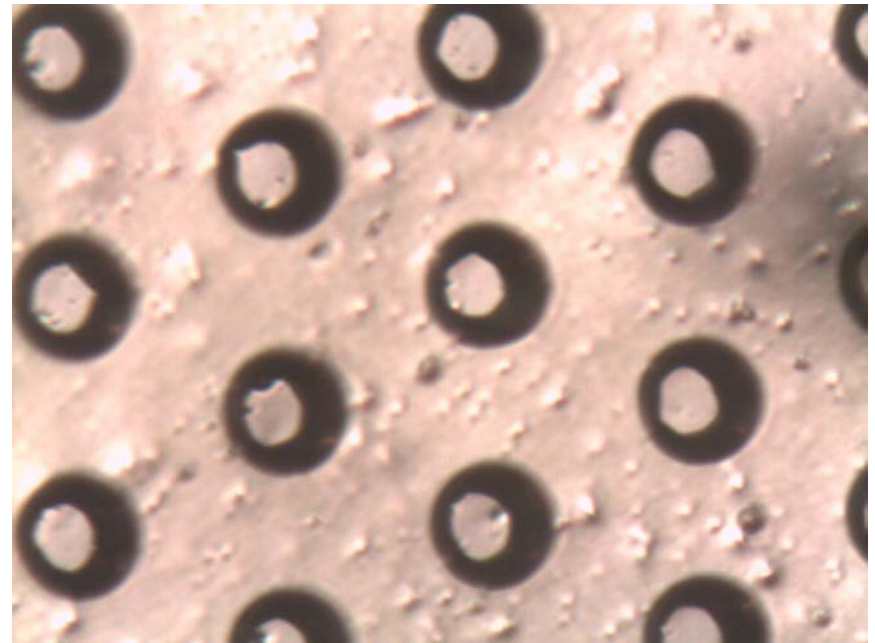
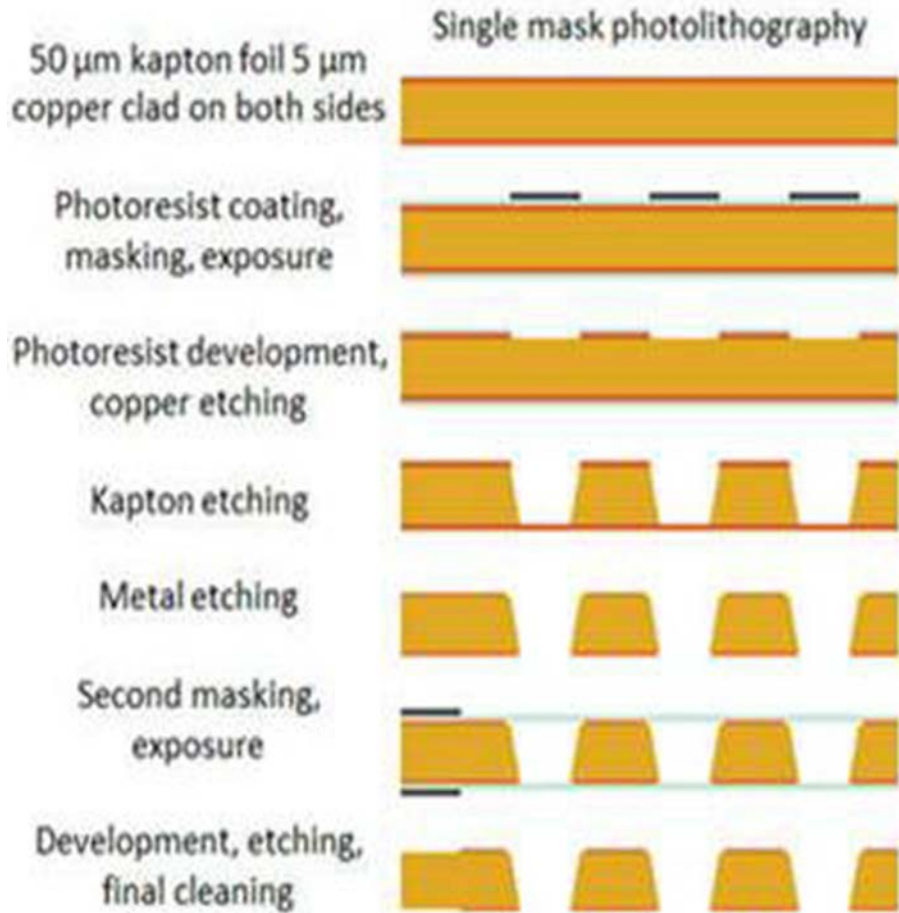
# Exposure of Dry Film Photoresist



# After First Copper Etching

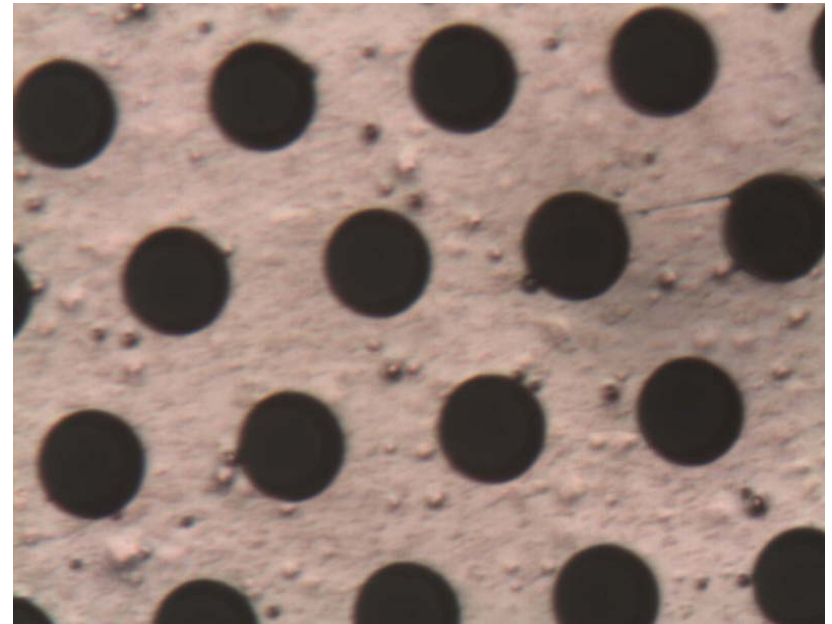
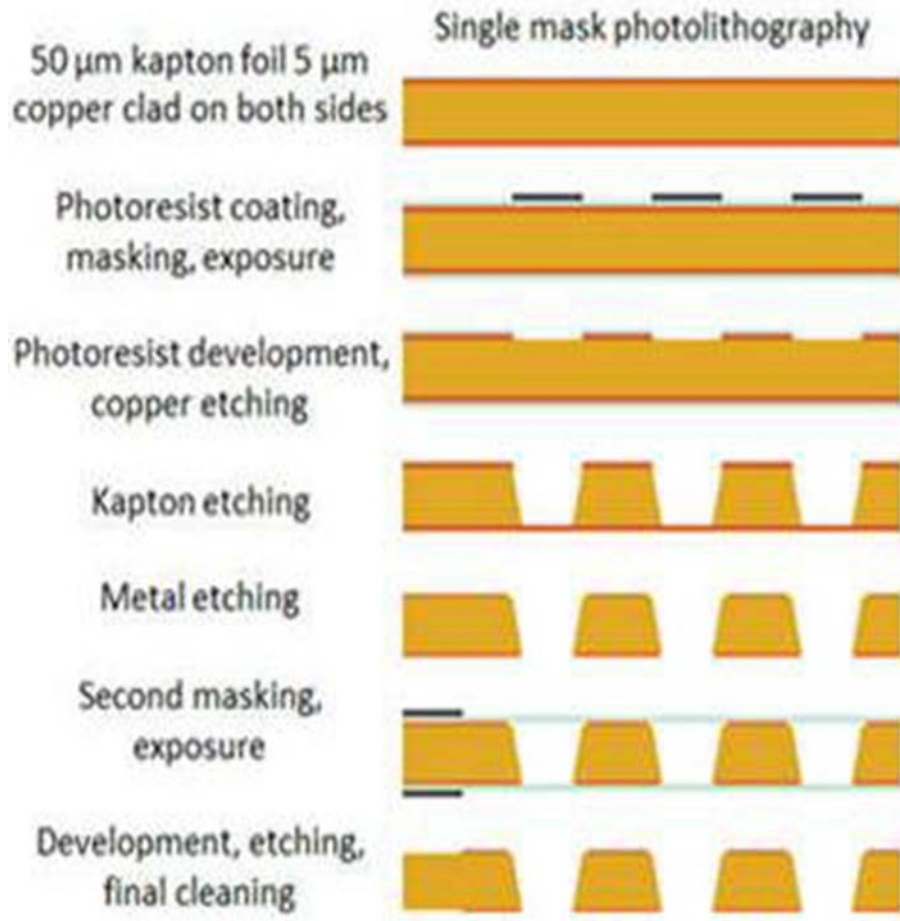


# After First Kapton Etching





# After Second Copper Etching

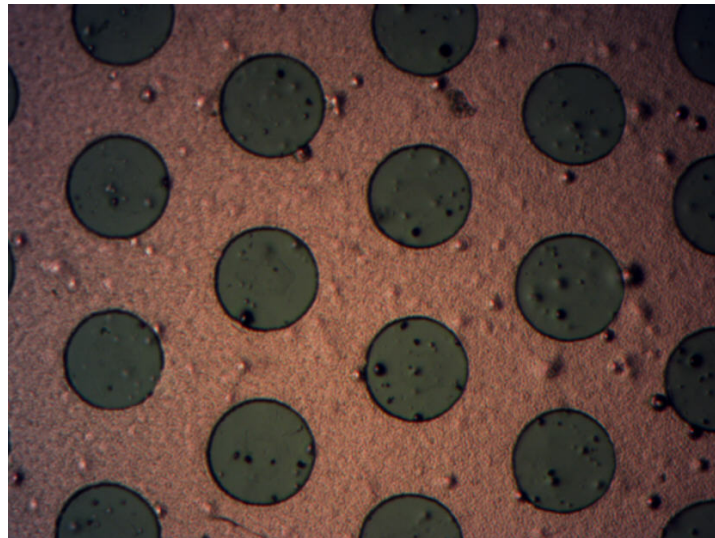
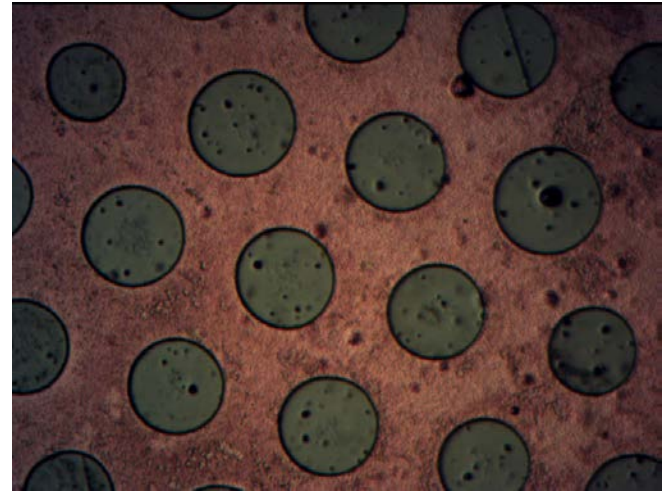
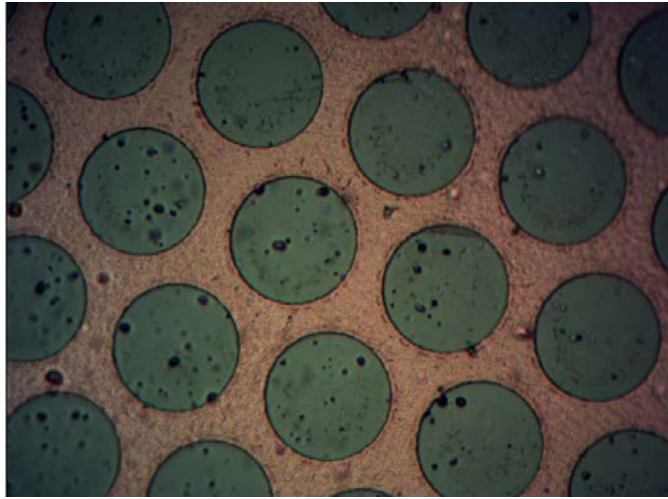


# 40cm\*40cm GEM Foil

- The 40cm\*40cm GEM foils were made successfully.
- Single-mask method was used.

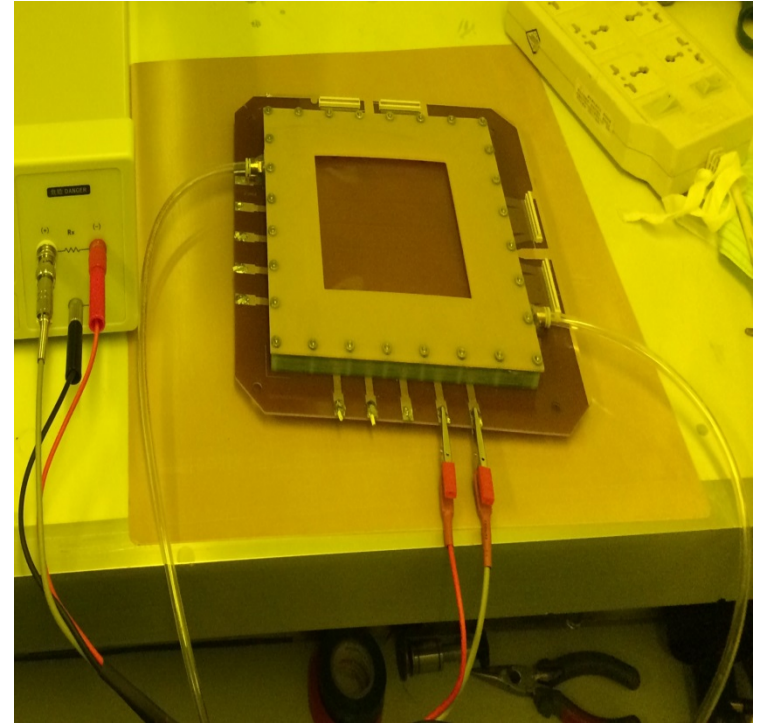
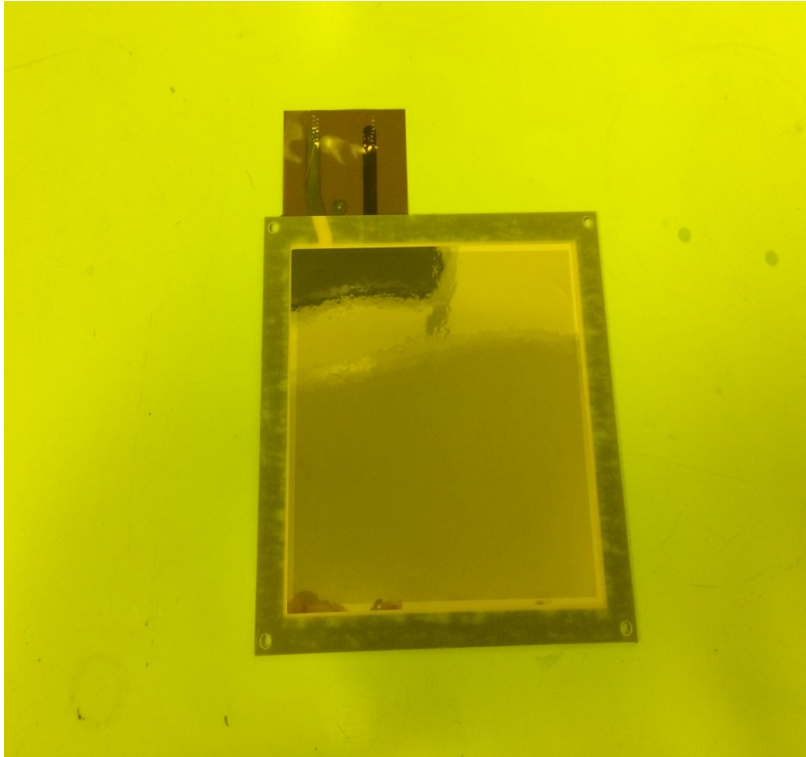


# New Chemical Reagents





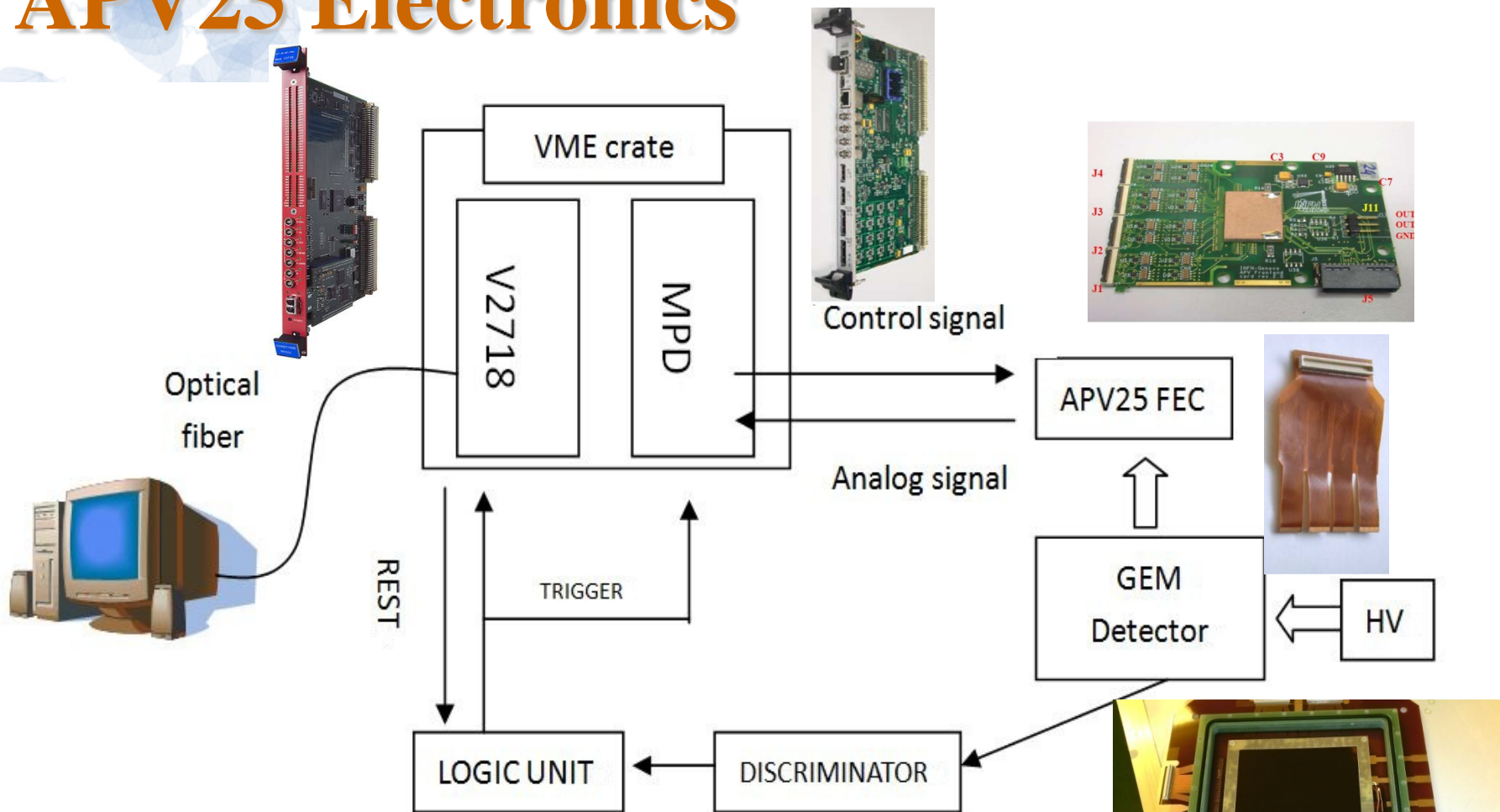
# Test



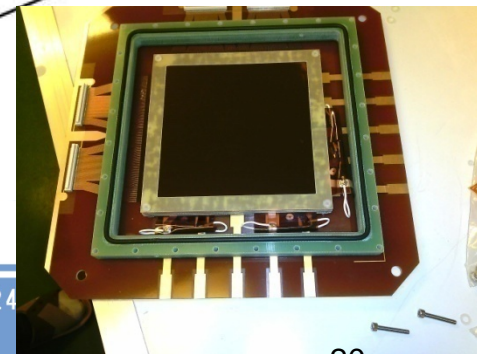
# Other Developments



# GEM Test system with APV25 Electronics

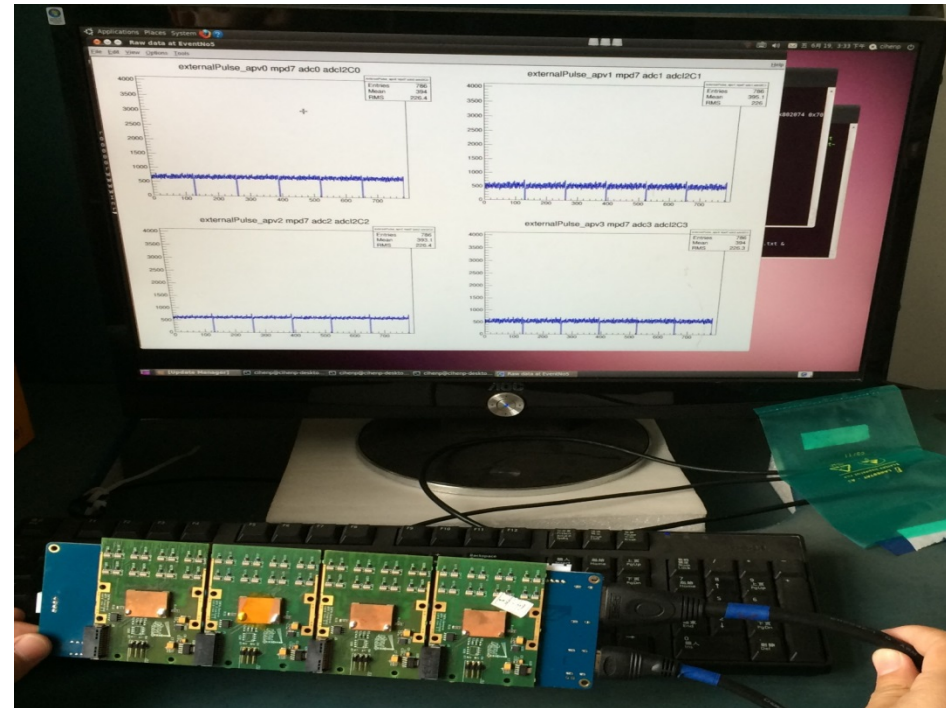


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# R&D of BackPlane



## Spatial resolution

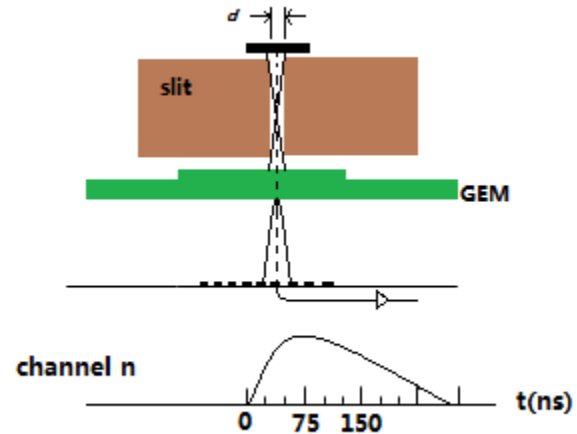
$$\sigma_{\text{tot}}^2 = \sigma_{\text{GEM}}^2 + c_1 \sigma_{\text{geometry}}^2$$

When:  $\sigma_{\text{geometry}} \ll \sigma_{\text{GEM}}$

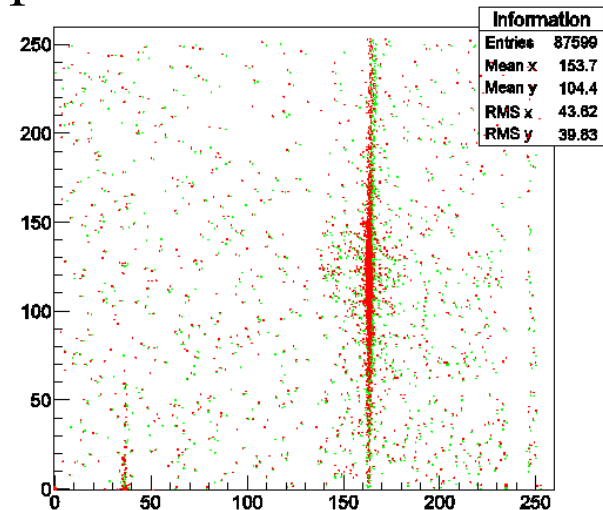
$$\sigma_{\text{tot}}^2 \cong \sigma_{\text{GEM}}^2$$

- Slit(um): 20;
- Ar: CO<sub>2</sub>=70% : 30%;
- HV: 3600V;
- The distance between strips: 400um;

$$\varepsilon=19.6\%$$

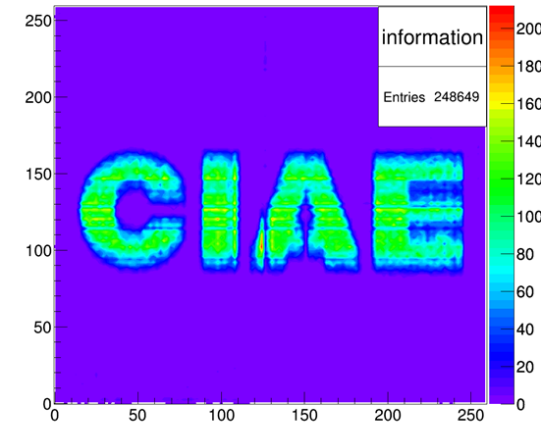


Spatial resolution  $\approx 76\mu\text{m}$

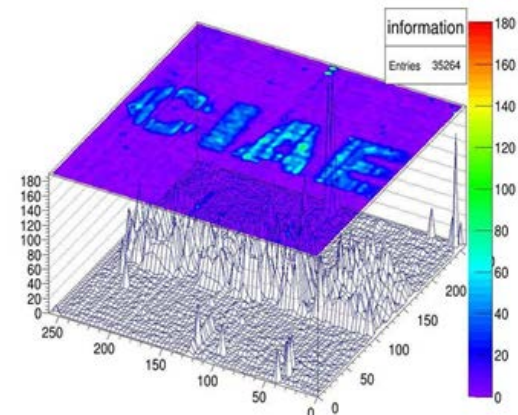




## X-ray imaging @ CIAE



- X ray Energy: 8.9KeV;
- about 1k sample rate
- 256 channels for each dimension( 512 channel in total);
- 4 APV FECs were used (2 for each dimension)



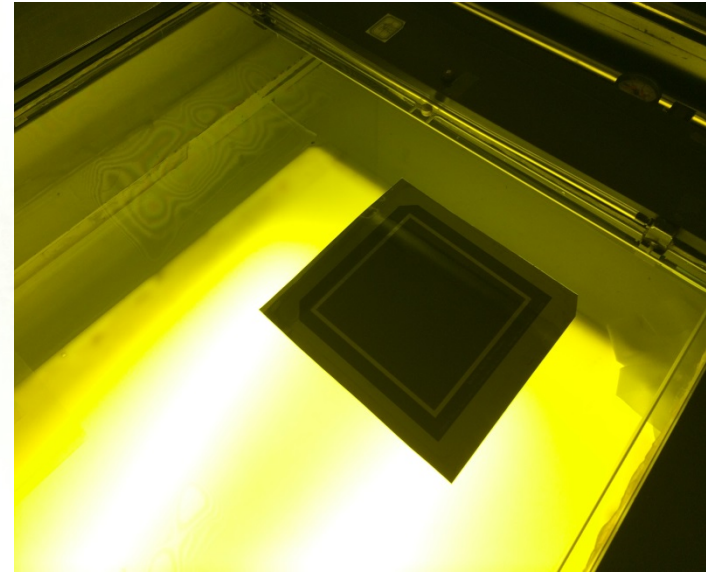
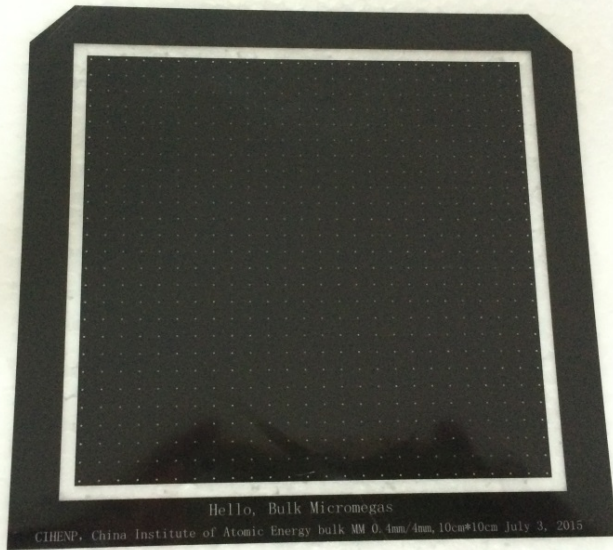
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# R&D of Bulk MicroMegas

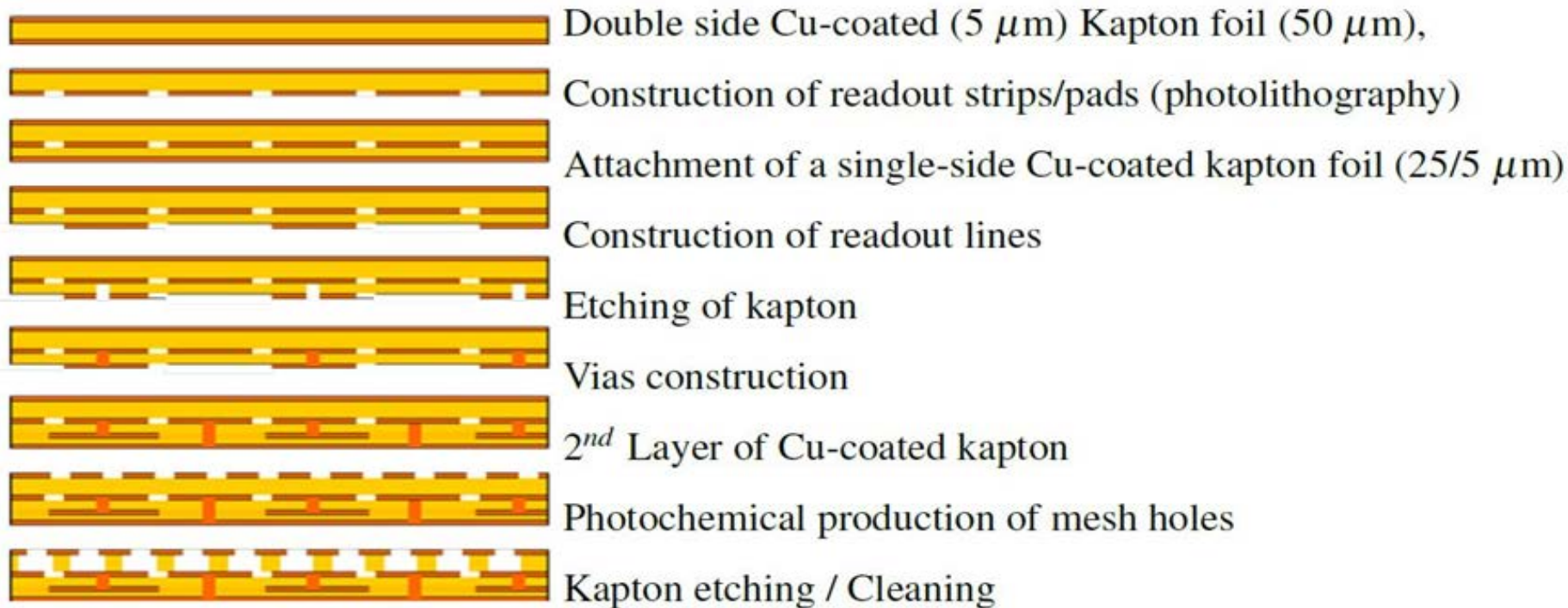
Based on the Collaboration with CEPC TPC (IHEP)



# R&D of MicroBulk MicroMegas

## Microbulk Micromegas Fabrication Process

This technology is inspired by  
the GEM detector fabrication process invented at CERN .

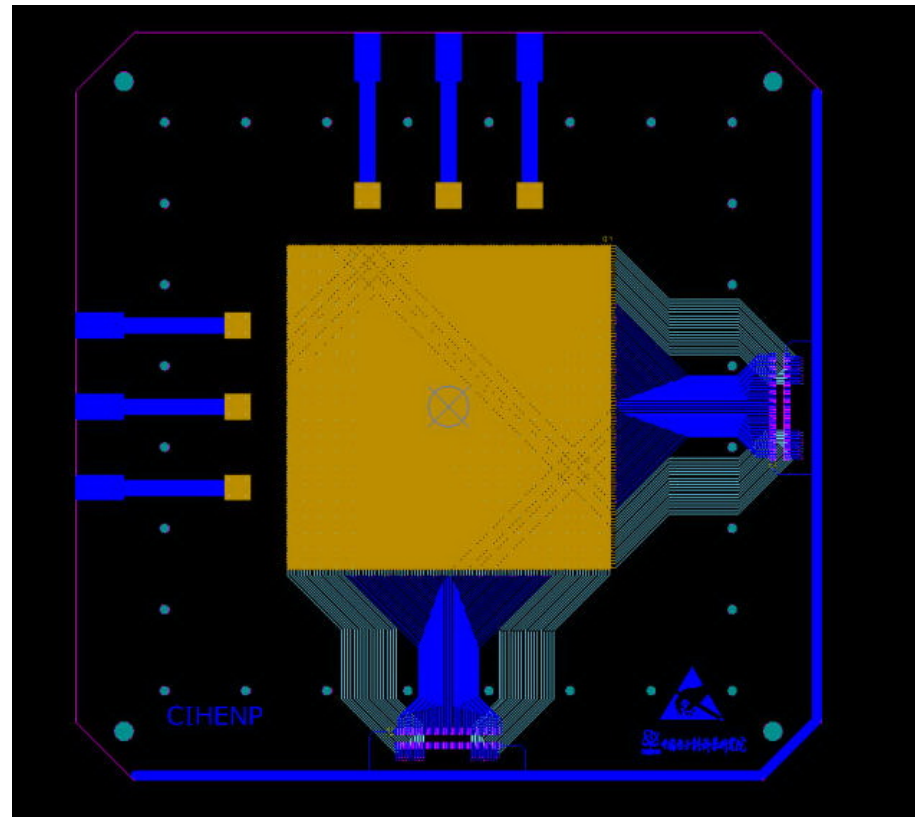


# Current Work on MicroBulk MicroMegas

Based on the Collaboration with PANDAXIII(SJTU)

New design of 10cm\*10cm MicroBulk MicroMegas

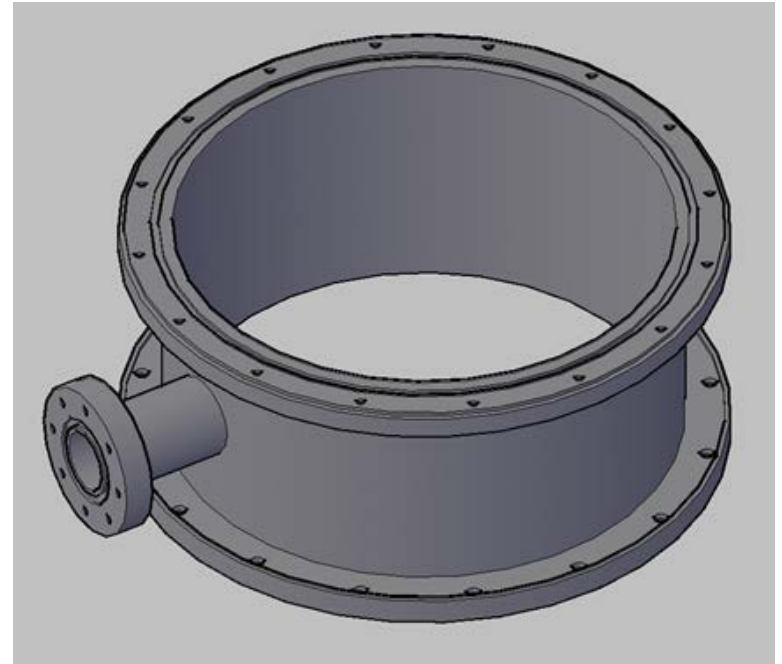
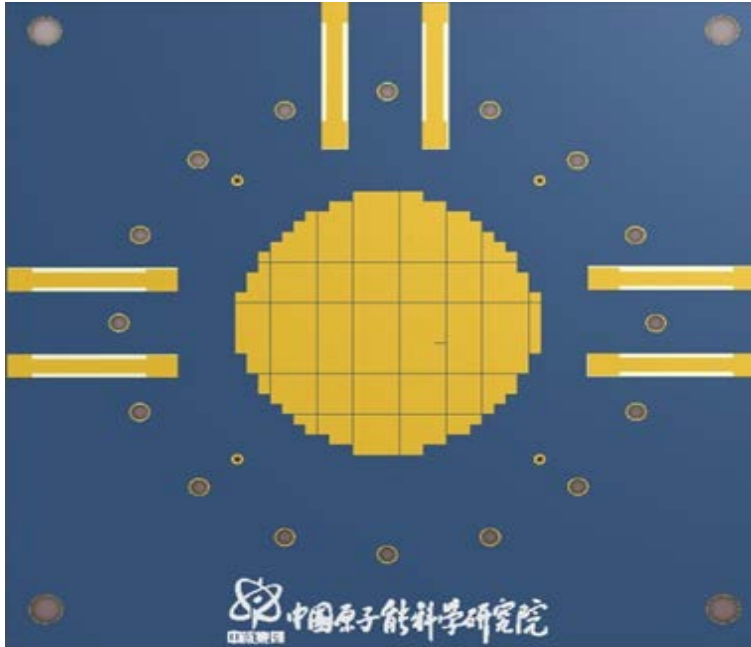
Prototype: XY readout, 200 APV25 electronics





# Next Step on on MicroBulk MicroMegas

New design of 20cm diameter round MicroBulk MicroMegas  
Prototype: 0.5cm<sup>2</sup> pad, 512 APV25 electronics



## 总结与展望

- 已经成功利用Double Mask和Single Mask技术分别研制出30cm\*30cm 和40cm\*40cm GEM 膜。
- 完成了GEM探测器APV25电子学分辨和成像研究
- 用自己研发的GEM膜制成GEM探测器并进行测试。降低废品率。如果顺利的话，就可以尝试进行GEM膜小批量生产。
- 利用与GEM膜工艺非常相近的光刻蚀刻技术进行新型微网探测器研制。



感谢核探测器与核电子学国家重点实验室开放基金支持！

Thank You !

